DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE WITH OVERLAY MARK

WITH OVERLAY MARK the specification of which is attached here	eto unless the following box is checked:			
		Application Number or PCT International	Application Number	
	as amended on	_ (if applicable).		
hereby state that I have reviewed and mendment referred to above.	understand the contents of the above-ide	entified specification, including the claims,	as amended by ar	
acknowledge the duty to disclose info Regulations § 1.56.	ormation which is known by me to be m	aterial to patentability as defined in Title	37, Code of Feder	
nventor's certificate, or § 365(a) of any P and have also identified below any foreig that of the application on which priority is	PCT International application which designates application for patent or inventor's certifications of the control of the contr	9(a)-(d) or § 365(b) of any foreign applicated at least one country other than the Unite icate, or PCT International application having	d States, listed belo	
PRIOR FOREIGN APPLICATION(S))		****	
NUMBER	COUNTRY	DAY/MONTH/YEAR FILED	PRIORITY CLAIMED	
2002-47249	Republic of Korea	9/August/2002	Yes	
	:			
hereby claim the benefit under Title 35,	United States Code § 119(e) of any United	States provisional application(s) listed belo	w.	
APPLICATION NO.		FILING DATE		
		 		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is known by me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

APPLICATION SERIAL NO.	FILING DATE	STATUS: PATENTED, PENDING, ABANDONED	
	•		

I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Eugene M. Lee, Reg. No. 32,039; Richard A. Sterba, Reg. No. 43,162.

Address all correspondence to Eugene M. Lee, LEE & STERBA, PC, 1101 Wilson Boulevard, Suite 2000, Arlington, Virginia 22209. Address all telephone communications to Eugene M. Lee at (703) 525-0978.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of First or Sole Inventor	Signature of Fir	st or Sole Inventor	Date
Dae-Joung KIM		km '	sure. 11
Residence Address 632-1701 Sinmyeong Apt., Youngtong-dong, Paldal-gu,	Suwon-si,	Country of Citizenship Republic of Korea	
Gyeonggi-do, Republic of Korea			
	• 44. 		
Post Office Address			• .
Same as above			
		 	
Full Name of Second Inventor	Signature of Sec	cond Inventor	Date
Full Name of Second Inventor Seok-Hwan OH	Signature of Sec	cond Inventor	June 11
	Signature of Sec	Country of Citizenship	
Seok-Hwan OH	1/21	APP .	June 11
Seok-Hwan OH Residence Address	1/21	Country of Citizenship	June 11
Residence Address 206-1503 Byeoksan Apt., #832-1, Jukjeon-ri, Suji-eup Y	1/21	Country of Citizenship	June 11
Residence Address 206-1503 Byeoksan Apt., #832-1, Jukjeon-ri, Suji-eup Y	1/21	Country of Citizenship	June 11
Seok-Hwan OH Residence Address 206-1503 Byeoksan Apt., #832-1, Jukjeon-ri, Suji-eup Yo Gyeonggi-do, Republic of Korea	1/21	Country of Citizenship	June 11